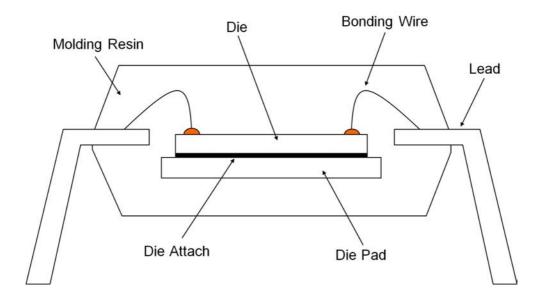


1. Package Information

Package Name	DIP8K
Туре	DIP
Pin Count	8
Package Weight [g]	0.5
Lead Finish	Pure Tin
MSL Level	-

2. Package Structure



3. Packing Specification

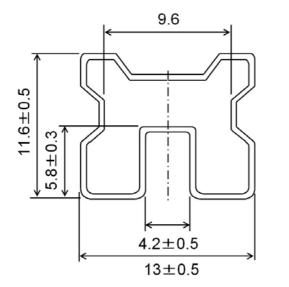
3.1 Packing form, Quar	ntity	
Packing Form		Tube
Packing Quantity	[pcs]	50

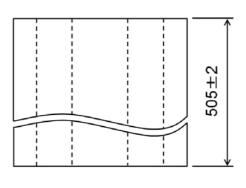
3.2 Use material

ltem	Material
Tube	PVC
Stopper	PVC
Unit box	Cardboard
Shipping box	Cardboard

3.3 Tube Specification

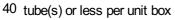
3.3.1 Tube Dimension

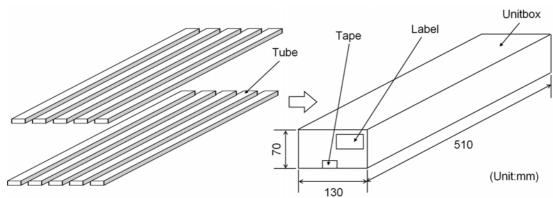




(unit:mm)

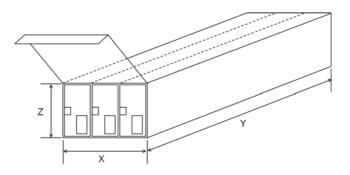
3.4 Packing Method





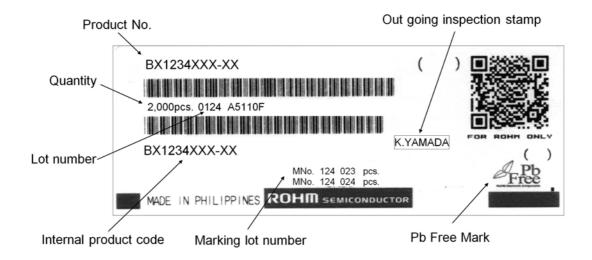
3.9 Packing Style

3 unit boxes or less per shipping box

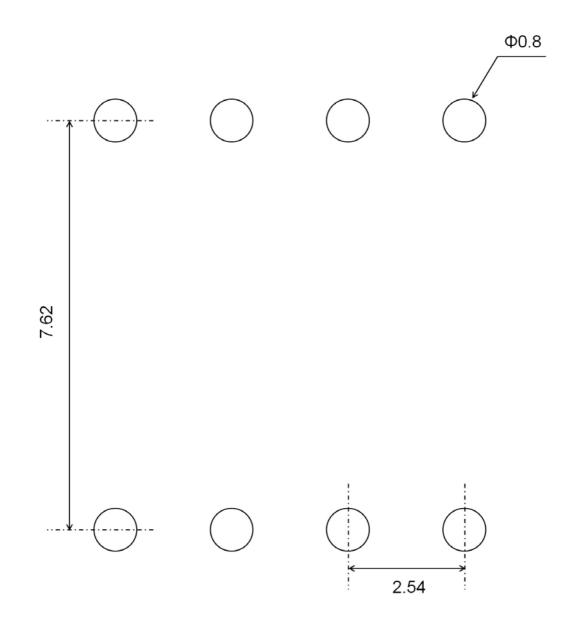


	(unit:mm)
Shipp	ing Box Dimension
Х	230
Y	579
Z	136

3.10 Label Specification



4. Footprint dimensions

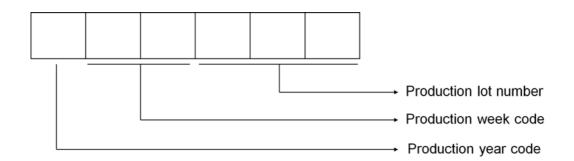


(unit:mm)

In actual design, please optimize in accordance with the situation of your board design and soldering condition.

DIP8K

5. Marking Specification



6. Storage conditions

6.1 Storage environment

Recommended stora	ge conditions		
	Min.	Max.	Unit
Temperature	5	30	°C
Humidity	40	70	% RH

6.2 Storage period

	Min.	Max.	Unit
Storage period	-	1	year

7. Soldering conditions

7.1 Recommended condition for wave soldering

Preheating temperature	:	120	°C to	150	°C
Preheating time	:	60	sec MA	Х	
Soldering temperature	:	260	°C ±	3	°C
Soldering time	:	12	sec MA	Х	

Notes for wave soldering

(1)Soldering time is provided for total soldering time in case of dual wave soldering.

(2) Do not use other soldering methods with wave soldering.

(3) Recommend to clean the board to eliminate flux, solder waste,

and other impurities for reliability, after soldering.

(4) Optimize soldering condition to prevent solder bridging.

7.2 Recommended condition for solder iron

Solder iron temperature	:	380	°C or less
Mounting time	:	4	sec or less

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3)	Although ROHM is continuously working to improve product reliability and quality, semicon- ductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
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5)	The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
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7)	The Products specified in this document are not designed to be radiation tolerant.
8)	For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
9)	Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
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